

TECHNICAL DATA SHEET

PLATAMID® HX 2620 POWDER

COPOLYAMIDE POWDER

PLATAMID® HX 2620 POWDER is a thermoplastic copolyamide hot melt adhesive. This low melt viscosity grade is used to manufacture fusible interlinings. It offers good laundry resistance and good steam resistance at low/medium fusing conditions

This product is available in different grain sizes:

- PA80 (0-80 µm paste dot)
- PRA 170 (0-170 µm double dot)

TYPE

PA*

MAIN APPLICATIONS

- Adhesives - Apparel/Interlining
- Coating Additives - Adhesive And Sealant
- Graphic Arts Additives -Transfer Paper

DELIVERY FORM

- Powder

TRANSFORMATION PROCESSES

- Scattering, paste, double dot

RHEOLOGICAL PROPERTIES

PROPERTIES	VALUE	UNIT	TEST STANDARD
Melt volume flow rate (MVR), 150°C / 2.16 kg (302°F / 4.4 lb)	41.5	cm³/10min	ISO 1133

THERMAL PROPERTIES

PROPERTIES	VALUE	UNIT	TEST STANDARD
Melting temperature, 10°C/min	124	°C	ISO 11357-1/-3

PACKAGING

Available packaging:

- 20 kg / 44 lb bags

SHELF LIFE

Two years from the date of delivery, when stored properly (sealed bags, appropriate moisture, UV protection and temperature). For any use above this limit, please refer to our technical services.